## **GENERAL UNDERGRADUATE SCHOLARSHIP APPLICATION Department of Chemical Engineering, Brigham Young University**

This scholarship will be awarded to students pursuing a degree in Chemical Engineering. Academic merit, service, and financial need will be considered in selecting the recipient. The application deadline is April 1<sup>st</sup> for the following fall and winter semesters.

Last Name:	First	st:	MI:
Student ID No.:	Em	ail Address:	
NOTIFICATION WILL <u>NO</u> PHYSICAL ADDRESS WE MAILED.			
Street:			Apt:
City:	State:	7	Zip Code:
Phone:			
Class Standing: ☐ Freshm Anticipated Graduation Date	*	e 🗆 Junior	□ Senior
I am applying for:  Fall Semester  Credit hours in the semester  (You must be registered for at lea least 28 credits for fall and winter	st 14 credit hours for the	eking aid:semester for which yo	ou are seeking aid or at
Overall GPA Majo	or GPA		
Are you currently working? If so, indicate how many ho			
Are you married?yes(If married) is your spouse a			n:
Do you have a Pell Grant or seeking aid?yes			ter for which you are
List all other scholarships/lo semester for which you are s			

## **Essay**

Attach a short essay explaining your involvement in the following: extracurricular, participation, service, leadership and research, any extenuating circumstances or obligations that affect your financial needs. Include the following: financial support from parents, non-student spouse, current scholarships, grants and existing loans.

## **Complete Back**

## **Student Certification**

I certify that the information furnished on this form is true to the best of my knowledge and that:

2. I will take at least	rolled as a full-time Chemical t 14 semester credit hours in the a total of at least 28 credit hours	ne semester for which I ar	
	he following chemical engined		ing semester:
the semester/term, o	if I withdraw from the chemic or fail to successfully complete I return the scholarship money	any of the above ChE co	ourses this
I agree to live by the	e BYU honor code, including	the dress and grooming s	tandards.
	rarded a scholarship, I will wring Scholarship Committee.	te a letter of appreciation	i to the
	Signature	I	Date
	Office Use		
BYU GPA	Total GPA	Need	
Other:			

Last printed 9/10/2010 3:29 PM